

	Hits	Search Text	DBs
1	1	("20040169444").PN.	US-PGPUB; USPAT; USOCR
2	13871	surface adj acoustic adj wave	EPO; JPO; DERWENT; IBM_TDB
3	117953	resin adj (film or layer)	EPO; JPO; DERWENT; IBM_TDB
4	1137874	dice\$1 or dicing or cut\$4 or split\$4	EPO; JPO; DERWENT; IBM_TDB
5	7	S2 and S3 and S4	EPO; JPO; DERWENT; IBM_TDB
6	103	S2 and S3	EPO; JPO; DERWENT; IBM_TDB
7	157725	saw or piezoelectric	EPO; JPO; DERWENT; IBM_TDB
8	129	S3 and S7 and S4	EPO; JPO; DERWENT; IBM_TDB
9	123	S8 not S6	EPO; JPO; DERWENT; IBM_TDB
10	2664119	resin or film	EPO; JPO; DERWENT; IBM_TDB
11	347	S2 and S4 and S10	EPO; JPO; DERWENT; IBM_TDB
12	965613	roll or roller	EPO; JPO; DERWENT; IBM_TDB
13	1	S11 and S12	EPO; JPO; DERWENT; IBM_TDB
14	340	S11 not S6	EPO; JPO; DERWENT; IBM_TDB
15	53	S2 and S12	EPO; JPO; DERWENT; IBM_TDB
16	9496	flip adj chip	EPO; JPO; DERWENT; IBM_TDB
17	8	S16 and S10 and S12	EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
18	2	"2001332654"	EPO; JPO; DERWENT; IBM_TDB
19	2	"07176565"	EPO; JPO; DERWENT; IBM_TDB
20	3	"2002232260"	EPO; JPO; DERWENT; IBM_TDB
21	2	"2002198403"	EPO; JPO; DERWENT; IBM_TDB
22	2	"2000091381"	EPO; JPO; DERWENT; IBM_TDB
23	3	"2003283295"	EPO; JPO; DERWENT; IBM_TDB
24	1	"2002504773"	EPO; JPO; DERWENT; IBM_TDB
25	1	"97002596"	EPO; JPO; DERWENT; IBM_TDB
26	4	"972596"	EPO; JPO; DERWENT; IBM_TDB
27	9	"9702596"	EPO; JPO; DERWENT; IBM_TDB
28	1	("6262513").PN.	US-PGPUB; USPAT; USOCR
29	166	onozawa.in.	US-PGPUB; USPAT; USOCR
30	111523	SAW	US-PGPUB; USPAT; USOCR
31	12	S29 and S30	US-PGPUB; USPAT; USOCR
32	5	"2004032321"	EPO; JPO; DERWENT; IBM_TDB
33	3	"2003298389"	EPO; JPO; DERWENT; IBM_TDB
34	8655	surface adj acoustic adj wave	US-PGPUB; USPAT; USOCR

	Hits	Search Text	DBs
35	2924449	resin or film or sheet	US-PGPUB; USPAT; USOCR
36	1123640	roll or roller	US-PGPUB; USPAT; USOCR
37	63	S34 and S35 with S36	US-PGPUB; USPAT; USOCR
38	590	S34 and S36	US-PGPUB; USPAT; USOCR
39	1354452	thermoplastic or plastic or thermoset\$4	US-PGPUB; USPAT; USOCR
40	313	S38 and (S35 or S39)	US-PGPUB; USPAT; USOCR
41	250	S40 not S37	US-PGPUB; USPAT; USOCR
42	81629	piezoelectric	US-PGPUB; USPAT; USOCR
43	1925308	dice\$1 or dicing or cut\$4	US-PGPUB; USPAT; USOCR
44	3102	(S34 or S42) and (S35 or S39) same S36 and S43	US-PGPUB; USPAT; USOCR
45	2359	(S34 or S42) and (S35 or S39) with S36 and S43	US-PGPUB; USPAT; USOCR
46	49	S34 and (S35 or S39) with S36 and S43	US-PGPUB; USPAT; USOCR
47	7	S46 not S37	US-PGPUB; USPAT; USOCR
48	26742	S42 adj (element or device)	US-PGPUB; USPAT; USOCR
49	270	S48 with (S35 or S39) and (S35 or S39) with S36 and S43	US-PGPUB; USPAT; USOCR
50	14498	surface adj acoustic	EPO; JPO; DERWENT; IBM_TDB
51	966342	roll or roller	EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
52	13896	surface adj acoustic adj wave	EPO; JPO; DERWENT; IBM_TDB
53	966342	roll or roller	EPO; JPO; DERWENT; IBM_TDB
54	53	S52 and S53	EPO; JPO; DERWENT; IBM_TDB
55	10	S50 and S51 not S54	EPO; JPO; DERWENT; IBM_TDB
56	2000938	thermoplastic or plastic or thermoset\$4 or resin	EPO; JPO; DERWENT; IBM_TDB
57	2425716	film or sheet	EPO; JPO; DERWENT; IBM_TDB
58	63	S52 and S56 adj S57	EPO; JPO; DERWENT; IBM_TDB
59	3	"2001053577"	EPO; JPO; DERWENT; IBM_TDB
60	3	"2001110946"	EPO; JPO; DERWENT; IBM_TDB
61	1381894	electronic or chip	EPO; JPO; DERWENT; IBM_TDB
62	390	S61 and S56 adj S57 and S53	EPO; JPO; DERWENT; IBM_TDB
63	994855	dice\$1 or dicing or cut\$4	EPO; JPO; DERWENT; IBM_TDB
64	62	S62 and S63	EPO; JPO; DERWENT; IBM_TDB
65	328	S62 not S64	EPO; JPO; DERWENT; IBM_TDB
66	3511	S52 and (S56 or S57)	EPO; JPO; DERWENT; IBM_TDB
67	1873163	board or substrate	EPO; JPO; DERWENT; IBM_TDB
68	2597	S66 and S67	EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
69	279	S68 and S63	EPO; JPO; DERWENT; IBM_TDB
70	1193369	electronic or chip	US-PGPUB; USPAT; USOCR
71	1221119	board or substrate	US-PGPUB; USPAT; USOCR
72	1294	(S34 or S70) and S71 and (S39 or resin) adj (film or sheet or layer) with S36	US-PGPUB; USPAT; USOCR
73	171538	(S39 or resin) adj (film or sheet or layer)	US-PGPUB; USPAT; USOCR
74	149	(S34 or S70) with S71 and (S34 or S70) with S73 and S73 with S36	US-PGPUB; USPAT; USOCR
75	7081	(S34 or S70) with S71 and (S35 or S39) with S36	US-PGPUB; USPAT; USOCR
76	4360	S75 and S43	US-PGPUB; USPAT; USOCR
77	122479	"156"/\$7.ccls.	US-PGPUB; USPAT; USOCR
78	464	S76 and S77	US-PGPUB; USPAT; USOCR
79	17424	flip adj chip	US-PGPUB; USPAT; USOCR
80	54	S79 and S73 with S36	US-PGPUB; USPAT; USOCR
81	179550	encapsulat\$3	US-PGPUB; USPAT; USOCR
82	563	S79 and S81 and S36	US-PGPUB; USPAT; USOCR
83	50	S79 and S81 same S36	US-PGPUB; USPAT; USOCR
84	1	("6262513").PN.	US-PGPUB; USPAT; USOCR

	Hits	Search Text	DBs
85	20	("4364017"   "4734608"   "5010270"   "5243250").PN. OR ("6262513").URPN.	US-PGPUB; USPAT; USOCR
86	65	S34 and (package or encapsulat\$3) and roller	US-PGPUB; USPAT; USOCR
87	8655	surface adj acoustic adj wave	US-PGPUB; USPAT; USOCR
88	65	S88 and (package or encapsulat\$3) and roller	US-PGPUB; USPAT; USOCR
89	65	S88 and (package or encapsulat\$3) and roller	US-PGPUB; USPAT; USOCR
90	2	"2004253839"	EPO; JPO; DERWENT; IBM_TDB
91	9	"9702596"	EPO; JPO; DERWENT; IBM_TDB
92	2	"02186662"	EPO; JPO; DERWENT; IBM_TDB
93	2	"2001176995"	EPO; JPO; DERWENT; IBM_TDB
94	5	"2004032321"	EPO; JPO; DERWENT; IBM_TDB
95	2	"2002184884"	EPO; JPO; DERWENT; IBM_TDB
96	2038	SAW adj (chip or device)	EPO; JPO; DERWENT; IBM_TDB
97	9526	flip adj chip	EPO; JPO; DERWENT; IBM_TDB
98	966342	roll or roller	EPO; JPO; DERWENT; IBM_TDB
99	3901420	thermoplastic or plastic or thermoset\$4 or resin or sheet or film	EPO; JPO; DERWENT; IBM_TDB
100	11	S97 and (S98 or S100) and S99	EPO; JPO; DERWENT; IBM_TDB

	Hits	Search Text	DBs
101	85	S97 and S99	EPO; JPO; DERWENT; IBM_TDB
102	74	S102 not S101	EPO; JPO; DERWENT; IBM_TDB
103	536	S97 and (S98 or S100)	EPO; JPO; DERWENT; IBM_TDB
104	2841301	heat\$3 or soften\$3 or melt\$3	EPO; JPO; DERWENT; IBM_TDB
105	69	S104 and S105	EPO; JPO; DERWENT; IBM_TDB
106	1346545	seal\$3	US-PGPUB; USPAT; USOCR
107	756615	roller	US-PGPUB; USPAT; USOCR
108	16	S88 and S107 with S108	US-PGPUB; USPAT; USOCR
109	24	S88 and S107 same S108	US-PGPUB; USPAT; USOCR
110	8	S110 not S109	US-PGPUB; USPAT; USOCR
111	2626009	sheet or film	US-PGPUB; USPAT; USOCR
112	1465280	seal\$3 or encapsulant or encapsulat\$3	US-PGPUB; USPAT; USOCR
113	497765	"156"/\$7.ccls. or "310"/\$7.ccls. or "257"/\$7.ccls. or "438"/\$7.ccls. or "174"/\$7.ccls.	US-PGPUB; USPAT; USOCR
114	1604	S112 with S108 same S113 and S114	US-PGPUB; USPAT; USOCR
115	742	S112 with S108 with S113 and S114	US-PGPUB; USPAT; USOCR
116	1076062	electronic or S88 or SAW or piezoelectric	US-PGPUB; USPAT; USOCR

	Hits	Search Text	DBs
117	1221119	board or substrate	US-PGPUB; USPAT; USOCR
118	521	S115 and (S117 or S118)	US-PGPUB; USPAT; USOCR
119	1	("6262513").PN.	US-PGPUB; USPAT; USOCR
120	1	("4170811").PN.	EPO; JPO; DERWENT
121	2	"05055303"	EPO; JPO; DERWENT; IBM_TDB
122	13896	surface adj acoustic adj wave	EPO; JPO; DERWENT; IBM_TDB
123	4	(S97 or S123) and S100 and rolling	EPO; JPO; DERWENT; IBM_TDB
124	5	(S97 or S123) and S100 and (rolled or rolling)	EPO; JPO; DERWENT; IBM_TDB
125	3529	S112 with S113 with S108	US-PGPUB; USPAT; USOCR
126	64	S126 and S117 with S118	US-PGPUB; USPAT; USOCR
127	422789	chip	US-PGPUB; USPAT; USOCR
128	1725772	thermoplastic or plastic or thermoset\$4 or resin	US-PGPUB; USPAT; USOCR
129	526	S128 with S118 and S129 with S108	US-PGPUB; USPAT; USOCR
130	1109	S128 with S118 and S129 same S108	US-PGPUB; USPAT; USOCR
131	913	S131 and (S113 or packag\$3 or protect\$3)	US-PGPUB; USPAT; USOCR
132	475	S132 not S130	US-PGPUB; USPAT; USOCR
133	61345	inkjet or ink adj jet or printhead	US-PGPUB; USPAT; USOCR



	Hits	Search Text	DBs
134	351	S133 not S134	US-PGPUB; USPAT; USOCR
135	1087	310/313R.ccls.	US-PGPUB; USPAT; USOCR
136	756843	roller	US-PGPUB; USPAT; USOCR
137	5	S136 and S137	US-PGPUB; USPAT; USOCR
138	980	310/340,348.ccls.	US-PGPUB; USPAT; USOCR
139	12	S137 and S139	US-PGPUB; USPAT; USOCR
140	693	310/311.ccls.	US-PGPUB; USPAT; USOCR
141	18	S137 and S141	US-PGPUB; USPAT; USOCR
142	448044	rolled or rolling	US-PGPUB; USPAT; USOCR
143	51	S143 and (S136 or S139 or S141)	US-PGPUB; USPAT; USOCR
144	1	("6262513").PN.	US-PGPUB; USPAT; USOCR